

ACT® CMI-S

ORGANIC ETCH RESIDUE AND POSITIVE PHOTORESIST STRIPPER

ACT CMI-S is a corrosion inhibited water-soluble solution which effectively removes hardprocessed positive resist and organic etch residue from corrosion-sensitive metal alloy substrates.

BENEFITS

- Low etch rates on aluminum and aluminum alloys
- Completely water-soluble
- Operating temperature of 60°C to 75°C
- Compatible with wet bench and spray tool processes

TYPICAL PHYSICAL PROPERTIES

Specific Gravity: 0.940 **Boiling Point:** 164°C <-15°C Freezing Point: Flash Point (Open cup): 78°C Flash Point (Closed cup): 63°C Viscosity @25°C: 1.12 cSt pH (5% solution): 10.26

MATERIAL COMPATIBILITY

ACT CMI-S is compatible with the following materials used in the semiconductor industry*:

Test Conditions: 10 days at 22°C Test Conditions: 10 days at 80°C

Chemraz¹ 570 Halar 901 Kalrez² 6375 PFA

POE

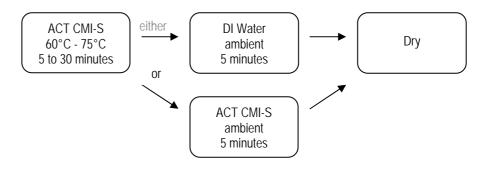
Polyethylene, Cross Linked Polyethylene, High Density Polyethylene, UHMW Polypropylene Stainless Steel 316L Stainless Steel 316LEP Teflon³ PTFE

INSTRUCTIONS FOR USE

PFA

Polyethylene, High Density Stainless Steel 316LEP

Teflon³ PTFE





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ETCH RATES

Etch Rates (Å/min)**								
Temp.	Al	Cu	Ti	Ta	TaN	W	TiN	TiW
75°C	1	18	<1	<1	<1	3	<1	1

^{**}Thickness measurements were performed using a CDE ResMap 273 four-point probe for metal films and the Nanospec⁴ AFT model 010-0180 film thickness measurement system for oxide films.

STORAGE, HANDLING, AND PROTECTIVE CLOTHING

Contact the Air Products Technical Center at 1-800-752-1597 or gastech@airproducts.com for a MSDS.



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